



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Jun-ichiro FURIHATA et al.

Group Art Unit: 2812

Application No.: 09/787,038

Examiner: C. Lattin

Filed: March 13, 2001

Docket No.: 108868

For: METHOD OF PRODUCING A BONDED WAFER AND THE BONDED WAFER

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In reply to the July 25, 2003, Office Action, and in conjunction with the Request for Continued Examination filed herewith, the following is submitted:

Amendments to the Claims are reflected in the listing of claims; and

Remarks.

RECEIVED
OCT 29 2003
TC 2800 MAIL ROOM